

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	255	"low k" and (copper or Cu) and interconnect and diffusion and barrier and treat\$4.clm.	US-PGPUB	OR	ON	2007/05/09 09:26
L3	75	"low k" and (copper or Cu) and " top surface" and interconnect and diffusion and barrier and treat\$4.clm.	US-PGPUB	OR	ON	2007/05/09 09:25
L4	260	"low k" and (copper or Cu) and " top surface" and interconnect and diffusion and barrier and treat\$4	US-PGPUB	OR	ON	2007/05/09 09:25
L5	922	"low k" and (copper or Cu) and interconnect and diffusion and barrier and (treat\$4 or implant\$4)	US-PGPUB	OR	ON	2007/05/09 09:26
L6	4659	((438/622) or (438/643) or (438/648) or (438/720)).CCLS.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/09 09:27
L8	33	huang-kuei-wu.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/09 09:29
L9	28	liu-ai-sen.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/09 09:30